

## **Product Specification**

## Part No.: SCJ-3574-SMT-C

- 1) Rating: DC 30V 0.3A
- 2) Operating Temperature Range: -10°C ~ +60°C
- **3) Electrical Performance:**

	Test Conditions	Performance	
Contact Resistance	Measured at small current (10mA	$50 \mathrm{m}\Omega$ Max.	
Contact Resistance	1000Hz or less)		
	Apply a voltage of 500V DC		
	shall be applied for 1 minute after		
	which measurement taken:		
Insulation Resistance	(1) Between terminals not to		
	be contact	$100 M\Omega$ Min.	
	(2) Between body and	10010122 101111.	
	terminal		
	(3) Between terminals not to		
	be contact when plug is		
	inserted		
Dielectric Strength	AC500V rms (50-60Hz) for 1		
	minute trip current: 0.5mA		
	(1) Between terminals not to		
	be contact.	Without domage to parts arging	
	(2) Between body and	Without damage to parts arcing or breakdown	
	terminal	or breakdown	
	(3) Between terminals not to		
	be contact when plug is		
	inserted.		

## 4) Mechanical Performance:

	Test Conditions	Performance	
Insertion Force	Measurement shall be made after 3 times of insertion and extraction with gauge plug	900~1800gf	
Extraction Force	Measurement shall be made after 3 times of insertion and extraction with gauge plug	700~1500gf	
Terminal Strength	A static load of 300gf shall be applied to the terminal for 15 seconds in any direction	Electrical characteristics shall be satisfied without damage or excessive looseness of terminals	
Life Test	Endurance without load: Jack shall be subjected to 5,000 cycles at a rate of 15 to 18 cycles per minute without loading.	<ol> <li>Contact resistance: 100mΩ Max.</li> <li>Insulation Resistance: 50MΩ Min.</li> <li>Withstand Voltage: AC 500V</li> </ol>	

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	(4)	for 1 minute. Without damage to parts arcing or breakdown.

## 5) Environmental Characteristics:

5) Environmental Cha	Test Conditions	Performance	
Solderability Test	The top of terminals shall be dipped 2mm in the solder bath of	The Area of soldering should be over 75%	
Resistance to Solder Heat Test	255±5°C for 3±0.5 seconds Solder bath method: Solder temperature 260±5°C. Immersion time within 10 sec. Immersion depth up to the surface of the board 1.6mm. Dimensions of component holes in the printed wiring board shall being accordance with those	Without deformation of case or excessive looseness of terminals electrical characteristics shall be satisfied.	
	being accordance with those specified in this specification.		
Cold Test Heat Test	The jack shall be stored at a temperature of $-25\pm$ 3°C for 48 hours, then the switch shall be maintained at standard atmospheric conditions for 1 hour after which measurement shall be made The jack shall be stored at a temperature of 70±2°C for 48 hours, then the jack shall be maintained at standard atmospheric conditions for 1 hour after which measurement shall be made.	There shall be no deformation or cracks in the molded part.	
Humidity Test	The jack shall be stored at a temperature of 40±2°C and a humidity of 90% to 98% for 48 hours, then the jack shall be maintained at standard atmospheric conditions for 1 hour after which measurement shall be made.	There shall be no deformation or cracks in molded part.	
Те	st Condition (Unless otherwise specifi Temperature: 5°C - 35°C Humidity: 45% - 85% R.H. Pressure: 86 – 106kPa	ied)	

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